MC14017B

Decade Counter

The MC14017B is a five–stage Johnson decade counter with built–in code converter. High speed operation and spike–free outputs are obtained by use of a Johnson decade counter design. The ten decoded outputs are normally low, and go high only at their appropriate decimal time period. The output changes occur on the positive–going edge of the clock pulse. This part can be used in frequency division applications as well as decade counter or decimal decode display applications.

- Fully Static Operation
- DC Clock Input Circuit Allows Slow Rise Times
- Carry Out Output for Cascading
- Divide–by–N Counting
- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- Capable of Driving Two Low–power TTL Loads or One Low–power Schottky TTL Load Over the Rated Temperature Range
- Pin–for–Pin Replacement for CD4017B
- Triple Diode Protection on All Inputs

L SUFFIX
CERAMIC
CASE 620

P SUFFIX
PLASTIC
CASE 648

D SUFFIX
SOIC
CASE 751B

ORDERING INFORMATION

MC14XXXBCP	Plastic
MC14XXXBCL	Ceramic
MC14XXXBD	SOIC

$T_A = -55°$ to $125°C$ for all packages.

MAXIMUM RATINGS* (Voltages Referenced to V_{SS})

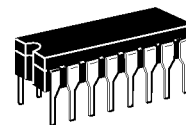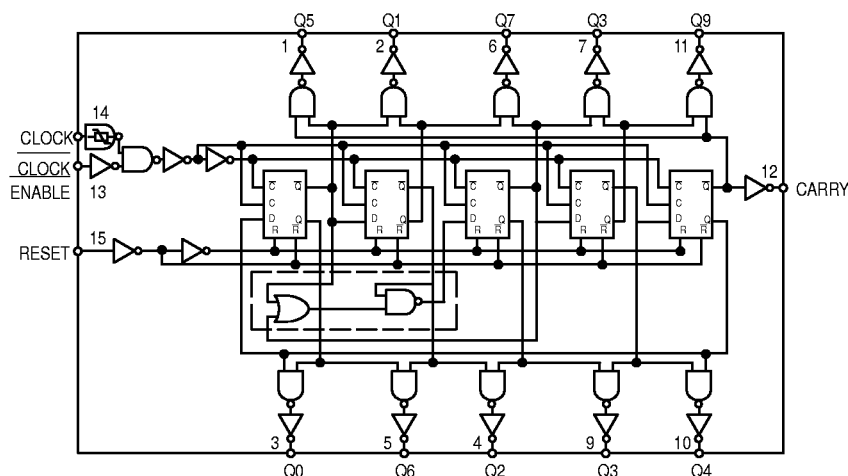| Symbol	Parameter	Value	Unit
V_{DD}	DC Supply Voltage	-0.5 to $+18.0$	V
V_{in}, V_{out}	Input or Output Voltage (DC or Transient)	-0.5 to $V_{DD} + 0.5$	V
I_{in}, I_{out}	Input or Output Current (DC or Transient), per Pin	± 10	mA
P_D	Power Dissipation, per Package†	500	mW
T_{stg}	Storage Temperature	-65 to $+150$	°C
T_L	Lead Temperature (8–Second Soldering)	260	°C

* Maximum Ratings are those values beyond which damage to the device may occur.
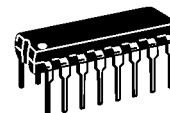† Temperature Derating:
    Plastic "P and D/DW" Packages: -7.0 mW/°C From 65°C To 125°C
    Ceramic "L" Packages: -12 mW/°C From 100°C To 125°C

FUNCTIONAL TRUTH TABLE
(Positive Logic)

Clock	Clock Enable	Reset	Decode Output=n
0	X	0	n
X	1	0	n
X	X	1	Q0
⟋	0	0	n+1
⟍	X	0	n
X	⟋	0	n
1	⟍	0	n+1

X = Don't Care. If n < 5 Carry = "1", Otherwise = "0".

LOGIC DIAGRAM

BLOCK DIAGRAM

V_{DD} = PIN 16
V_{SS} = PIN 8

MOTOROLA
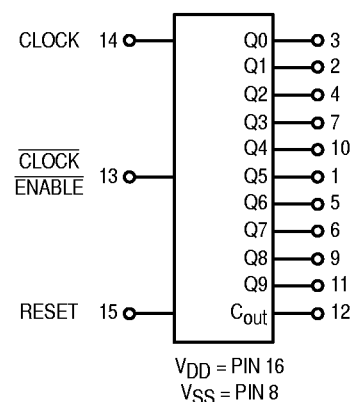
ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

Characteristic	Symbol	V_{DD} Vdc	$-55°C$ Min	$-55°C$ Max	25°C Min	25°C Typ #	25°C Max	125°C Min	125°C Max	Unit
Output Voltage "0" Level $V_{in} = V_{DD}$ or 0	V_{OL}	5.0	—	0.05	—	0	0.05	—	0.05	Vdc
		10	—	0.05	—	0	0.05	—	0.05	
		15	—	0.05	—	0	0.05	—	0.05	
"1" Level $V_{in} = 0$ or V_{DD}	V_{OH}	5.0	4.95	—	4.95	5.0	—	4.95	—	Vdc
		10	9.95	—	9.95	10	—	9.95	—	
		15	14.95	—	14.95	15	—	14.95	—	
Input Voltage "0" Level ($V_O = 4.5$ or 0.5 Vdc) ($V_O = 9.0$ or 1.0 Vdc) ($V_O = 13.5$ or 1.5 Vdc)	V_{IL}	5.0	—	1.5	—	2.25	1.5	—	1.5	Vdc
		10	—	3.0	—	4.50	3.0	—	3.0	
		15	—	4.0	—	6.75	4.0	—	4.0	
"1" Level ($V_O = 0.5$ or 4.5 Vdc) ($V_O = 1.0$ or 9.0 Vdc) ($V_O = 1.5$ or 13.5 Vdc)	V_{IH}	5.0	3.5	—	3.5	2.75	—	3.5	—	Vdc
		10	7.0	—	7.0	5.50	—	7.0	—	
		15	11	—	11	8.25	—	11	—	
Output Drive Current ($V_{OH} = 2.5$ Vdc) Source ($V_{OH} = 4.6$ Vdc) ($V_{OH} = 9.5$ Vdc) ($V_{OH} = 13.5$ Vdc)	I_{OH}	5.0	-3.0	—	-2.4	-4.2	—	-1.7	—	mAdc
		5.0	-0.64	—	-0.51	-0.88	—	-0.36	—	
		10	-1.6	—	-1.3	-2.25	—	-0.9	—	
		15	-4.2	—	-3.4	-8.8	—	-2.4	—	
($V_{OL} = 0.4$ Vdc) Sink ($V_{OL} = 0.5$ Vdc) ($V_{OL} = 1.5$ Vdc)	I_{OL}	5.0	0.64	—	0.51	0.88	—	0.36	—	mAdc
		10	1.6	—	1.3	2.25	—	0.9	—	
		15	4.2	—	3.4	8.8	—	2.4	—	
Input Current	I_{in}	15	—	± 0.1	—	±0.00001	± 0.1	—	± 1.0	µAdc
Input Capacitance ($V_{in} = 0$)	C_{in}	—	—	—	—	5.0	7.5	—	—	pF
Quiescent Current (Per Package)	I_{DD}	5.0	—	5.0	—	0.005	5.0	—	150	µAdc
		10	—	10	—	0.010	10	—	300	
		15	—	20	—	0.015	20	—	600	
Total Supply Current**† (Dynamic plus Quiescent, Per Package) ($C_L = 50$ pF on all outputs, all buffers switching)	I_T	5.0	$I_T = (0.27$ µA/kHz$) f + I_{DD}$							µAdc
		10	$I_T = (0.55$ µA/kHz$) f + I_{DD}$							
		15	$I_T = (0.83$ µA/kHz$) f + I_{DD}$							

#Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

**The formulas given are for the typical characteristics only at 25°C.

†To calculate total supply current at loads other than 50 pF:

$$I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) Vfk$$

where: I_T is in µA (per package), C_L in pF, V = ($V_{DD} - V_{SS}$) in volts, f in kHz is input frequency, and k = 0.0011.

PIN ASSIGNMENT

Q5	1 ●	16	V_{DD}
Q1	2	15	RESET
Q0	3	14	CLOCK
Q2	4	13	$\overline{CE}$
Q6	5	12	C_{out}
Q7	6	11	Q9
Q3	7	10	Q4
V_{SS}	8	9	Q8

SWITCHING CHARACTERISTICS* (C_L = 50 pF, T_A = 25°C)

Characteristic	Symbol	V_{DD} Vdc	Min	Typ #	Max	Unit
Output Rise and Fall Time t_{TLH}, t_{THL} = (1.5 ns/pF) C_L + 25 ns t_{TLH}, t_{THL} = (0.75 ns/pF) C_L + 12.5 ns t_{TLH}, t_{THL} = (0.55 ns/pF) C_L + 9.5 ns	t_{TLH}, t_{THL}	 5.0 10 15	 — — —	 100 50 40	 200 100 80	ns
Propagation Delay Time Reset to Decode Output t_{PLH}, t_{PHL} = (1.7 ns/pF) C_L + 415 ns t_{PLH}, t_{PHL} = (0.66 ns/PF) C_L + 197 ns t_{PLH}, t_{PHL} = (0.5 ns/pF) C_L + 150 ns	t_{PLH}, t_{PHL}	 5.0 10 15	 — — —	 500 230 175	 1000 460 350	ns
Propagation Delay Time Clock to C_{out} t_{PLH}, t_{PHL} = (1.7 ns/pF) C_L + 315 ns t_{PLH}, t_{PHL} = (0.66 ns/pF) C_L + 142 ns t_{PLH}, t_{PHL} = (0.5 ns/pF) C_L + 100 ns	t_{PLH}, t_{PHL}	 5.0 10 15	 — — —	 400 175 125	 800 350 250	ns
Propagation Delay Time Clock to Decode Output t_{PLH}, t_{PHL} = (1.7 ns/pF) C_L + 415 ns t_{PLH}, t_{PHL} = (0.66 ns/pF) C_L + 197 ns t_{PLH}, t_{PHL} = (0.5 ns/pF) C_L + 150 ns	t_{PLH}, t_{PHL}	 5.0 10 15	 — — —	 500 230 175	 1000 460 350	ns
Turn–Off Delay Time Reset to C_{out} t_{PLH} = (1.7 ns/pF) C_L + 315 ns t_{PLH} = (0.66 ns/pF) C_L + 142 ns t_{PLH} = (0.5 ns/pF) C_L + 100 ns	t_{PLH}	 5.0 10 15	 — — —	 400 175 125	 800 350 250	ns
Clock Pulse Width	$t_{w(H)}$	5.0 10 15	250 100 75	125 50 35	— — —	ns
Clock Frequency	f_{cl}	5.0 10 15	— — —	5.0 12 16	2.0 5.0 6.7	MHz
Reset Pulse Width	$t_{w(H)}$	5.0 10 15	500 250 190	250 125 95	— — —	ns
Reset Removal Time	t_{rem}	5.0 10 15	750 275 210	375 135 105	— — —	ns
Clock Input Rise and Fall Time	t_{TLH}, t_{THL}	5.0 10 15		No Limit		—
Clock Enable Setup Time	t_{su}	5.0 10 15	350 150 115	175 75 52	— — —	ns
Clock Enable Removal Time	t_{rem}	5.0 10 15	420 200 140	260 100 70	— — —	ns

* The formulas given are for the typical characteristics only at 25°C.
#Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.
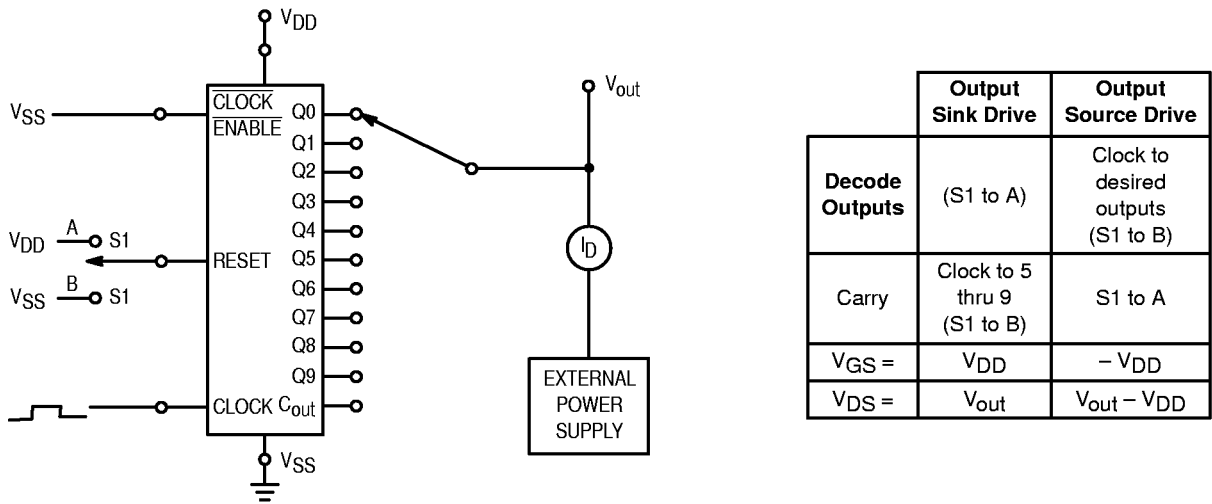
	Output Sink Drive	Output Source Drive
Decode Outputs	(S1 to A)	Clock to desired outputs (S1 to B)
Carry	Clock to 5 thru 9 (S1 to B)	S1 to A
$V_{GS} =$	V_{DD}	$-V_{DD}$
$V_{DS} =$	V_{out}	$V_{out} - V_{DD}$

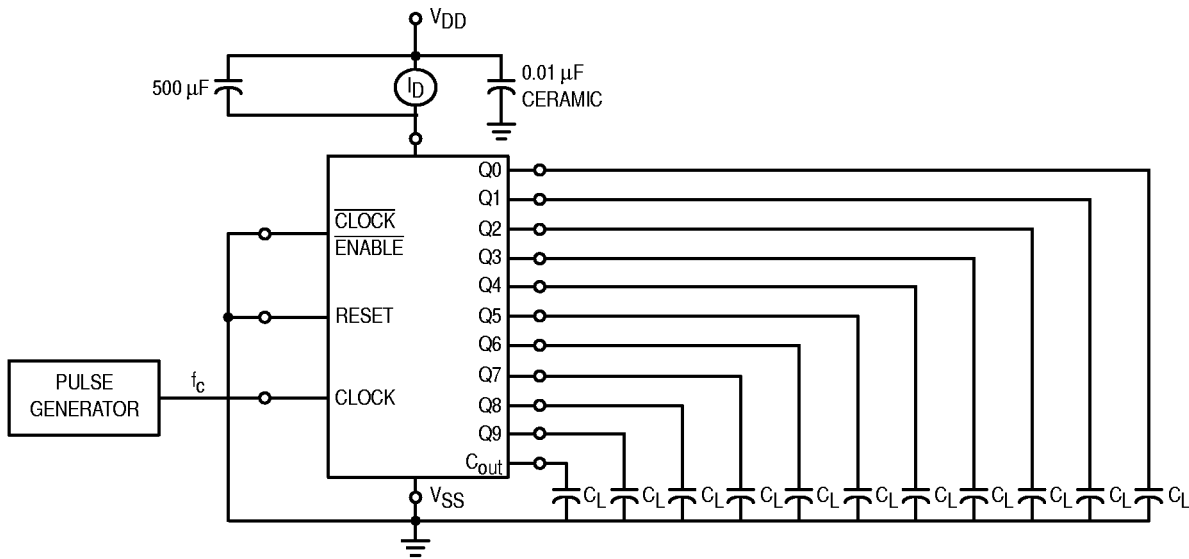**Figure 1. Typical Output Source and Output Sink Characteristics Test Circuit**

Figure 2. Typical Power Dissipation Test Circuit

APPLICATIONS INFORMATION

Figure 3 shows a technique for extending the number of decoded output states for the MC14017B. Decoded outputs are sequential within each stage and from stage to stage, with no dead time (except propagation delay).
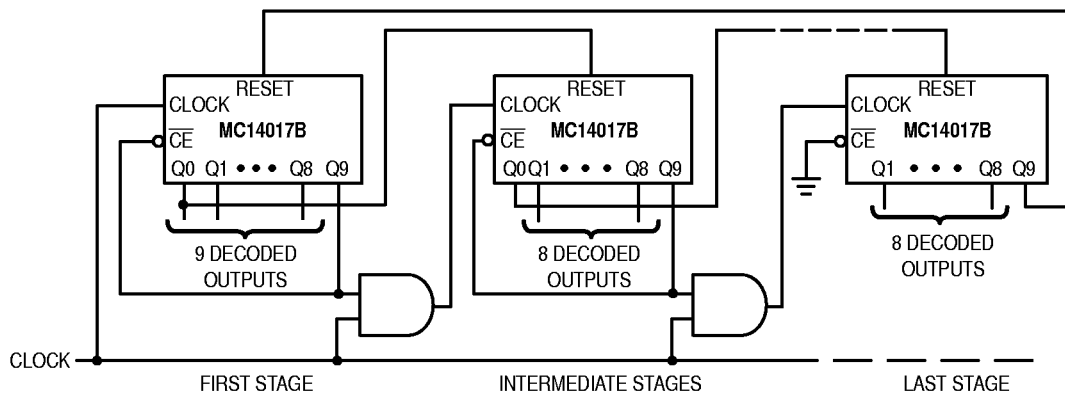
Figure 3. Counter Expansion
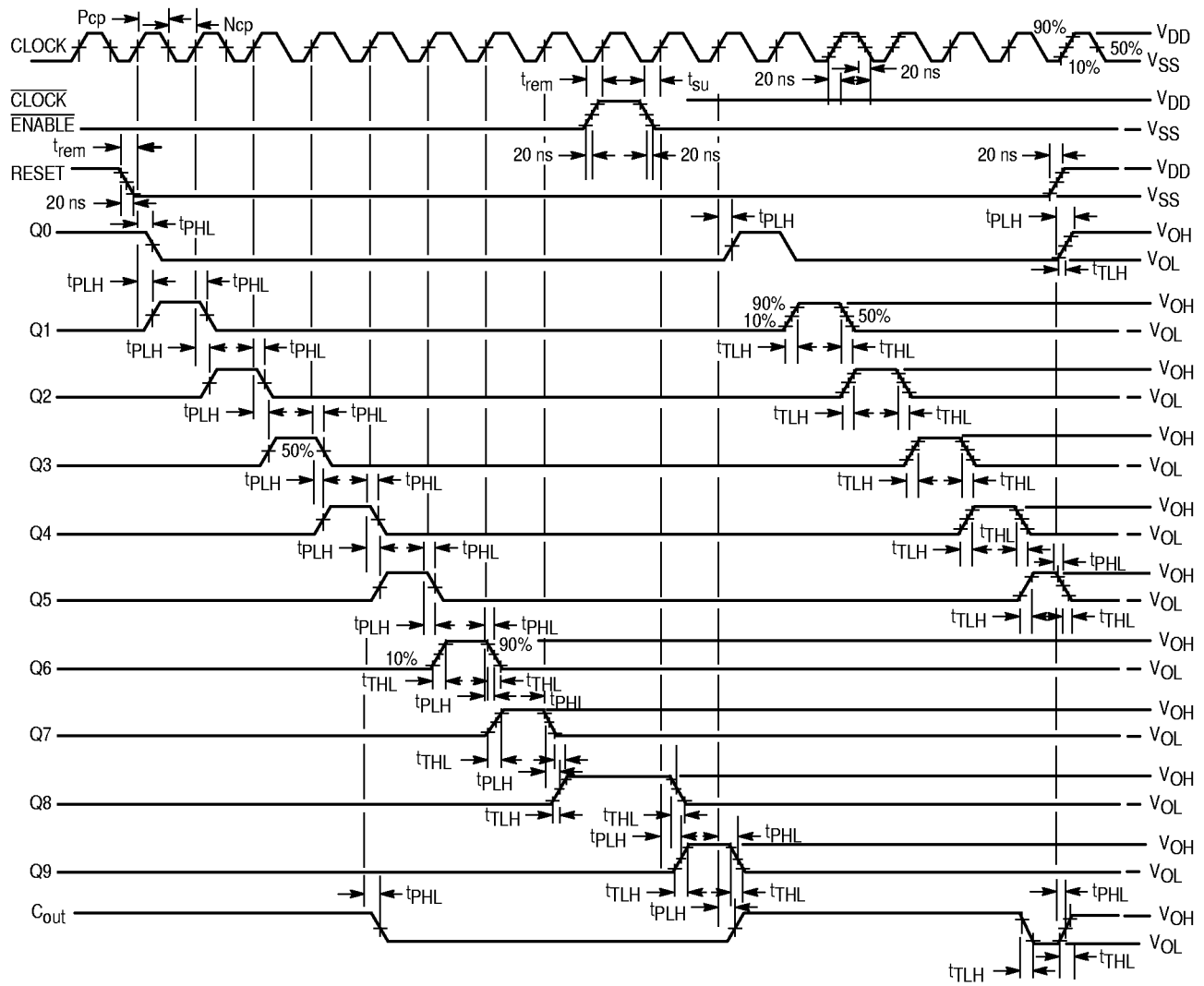
Figure 4. AC Measurement Definition and Functional Waveforms

OUTLINE DIMENSIONS

L SUFFIX
CERAMIC DIP PACKAGE
CASE 620–10
ISSUE V
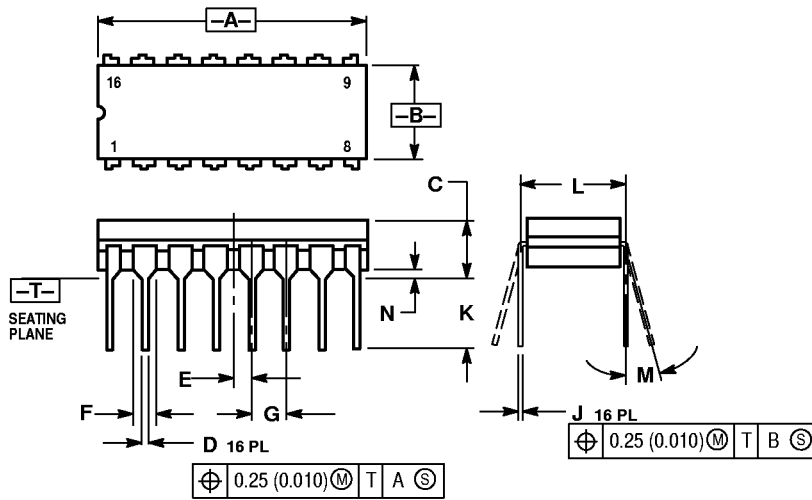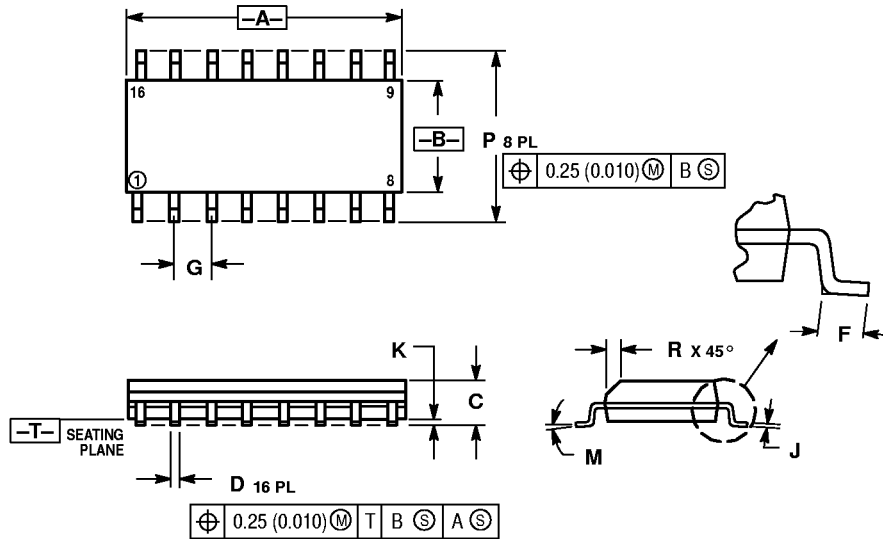

NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES MIN	INCHES MAX	MILLIMETERS MIN	MILLIMETERS MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	—	0.200	—	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0 °	15°	0 °	15°
N	0.020	0.040	0.51	1.01

P SUFFIX
PLASTIC DIP PACKAGE
CASE 648–08
ISSUE R
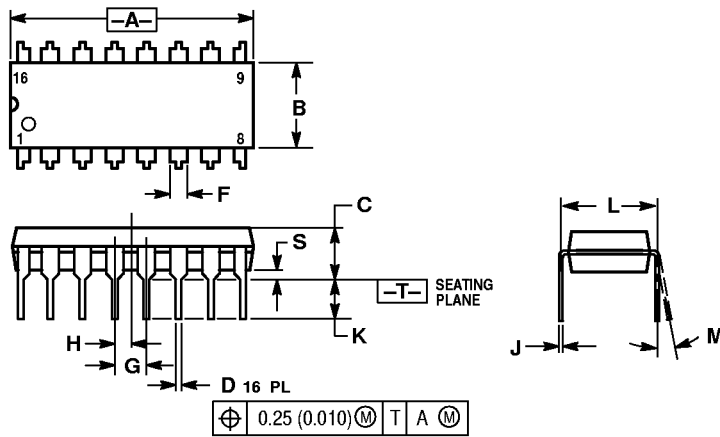
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES MIN	INCHES MAX	MILLIMETERS MIN	MILLIMETERS MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0 °	10°	0 °	10°
S	0.020	0.040	0.51	1.01

OUTLINE DIMENSIONS

D SUFFIX
PLASTIC SOIC PACKAGE
CASE 751B–05
ISSUE J

NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

Ⓜ **MOTOROLA**

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